

Silicon Carbide Power MOSFET N-Channel Enhancement Mode

Features

- 3rd generation SiC MOSFET technology
- Optimized package with separate driver source pin
- 8mm of creepage distance between drain and source
- High blocking voltage with low on-resistance
- High-speed switching with low capacitances
- Fast intrinsic diode with low reverse recovery (Q,,)
- Halogen free, RoHS compliant

Benefits

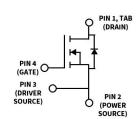
- Reduce switching losses and minimize gate ringing
- Higher system efficiency
- Reduce cooling requirements
- Increase power density
- Increase system switching frequency

Typical Applications

- Motor Control
- EV Battery Chargers
- High Voltage DC/DC Converters

Package









| Part Number | Package | Marking | |
|-------------|-----------|-------------|--|
| C3M0032120K | TO-247-4L | C3M0032120K | |

Key Parameters

| Parameter | Symbol | Min. | Тур. | Max | Unit | Conditions | Note |
|--|-----------------------------------|------|-------|----------------|--------------|---|-------------------|
| Drain - Source Voltage | V _{DS} | | | 1200 | | T _c = 25°C | |
| Maximum Gate - Source Voltage | V _{GS(max)} | -8 | | +19 | v | Transient | |
| Operational Gate-Source Voltage | V _{GS op} | | -4/15 | | | Static | Note 1 |
| | | | | 69 | А | $V_{GS} = 15 \text{ V}, T_{C} = 25 \text{ °C}, T_{J} \le 175 \text{ °C}$ | Fig. 19 Note 2 |
| DC Continuous Drain Current | I _D | | | 53 | | $V_{GS} = 15 \text{ V}, T_{C} = 100 \text{ °C}, T_{J} \le 175 \text{ °C}$ | |
| Pulsed Drain Current | I _{DM} | | | 264 | | t_{Pmax} limited by T_{jmax} $V_{GS} = 15V, T_{C} = 25 °C$ | Fig. 22 |
| Power Dissipation | P _D | | | 341 | W | $T_{c} = 25^{\circ} C, T_{J} = 175^{\circ} C$ | Fig. 20 |
| Operating Junction and Storage Temperature | T _J , T _{stg} | | | -40 to +175 | °C | | |
| Solder Temperature | T _L | | | 260 | | According to JEDEC J-STD-020 | |
| Mounting Torque | M _D | | | 1 8.8 | Nm Ibf-in | M3 or 6-32 screw | |

Note (1): Recommended turn-on gate voltage is 15V with $\pm 5\%$ regulation tolerance, see Application Note PRD-04814 for additional details Note (2): Verified by design

Electrical Characteristics (T_c = 25 °C unless otherwise specified)

| Symbol | Parameter | Min. | Тур. | Max. | Unit | Test Conditions | Note |
|---------------------------------|--|------|------|------|-------|---|----------|
| $V_{(BR)DSS}$ | Drain-Source Breakdown Voltage | 1200 | | | V | $V_{GS} = 0 \text{ V}, I_D = 100 \mu\text{A}$ | |
| V _{GS(th)} Gate Thresh | | 1.8 | 2.5 | 3.6 | V | $V_{DS} = V_{GS}, I_{D} = 11.5 \text{ mA}$ | Fig. 11 |
| | Gate Threshold Voltage | | 2.0 | | V | $V_{DS} = V_{GS}$, $I_D = 11.5$ mA, $T_J = 175$ °C | |
| I _{DSS} | Zero Gate Voltage Drain Current | | 1 | 50 | μΑ | V _{DS} = 1200 V, V _{GS} = 0 V | |
| I _{GSS} | Gate-Source Leakage Current | | 10 | 250 | nA | $V_{GS} = 15 \text{ V}, V_{DS} = 0 \text{ V}$ | |
| D | Drain-Source On-State Resistance | 23 | 32 | 43 | mΩ | $V_{GS} = 15 \text{ V}, I_D = 40 \text{ A}$ | Fig. 4, |
| R _{DS(on)} | Diani-Source Oil-State Resistance | | 57.6 | | 11122 | $V_{GS} = 15 \text{ V}, I_D = 40 \text{ A}, T_J = 175^{\circ}\text{C}$ | 5,6 |
| σ. | Transconductance | | 27 | | S | V _{DS} = 20 V, I _{DS} = 40 A | Fig. 7 |
| g _{fs} | Transconductance | | 22 | ļ | , | V_{DS} = 20 V, I_{DS} = 40 A, T_{J} = 175°C | |
| C _{iss} | Input Capacitance | | 3357 | | | | Fig. 17, |
| C_{oss} | Output Capacitance | | 129 | | pF | $V_{GS} = 0 \text{ V}, V_{DS} = 1000 \text{ V}$ | |
| C_{rss} | Reverse Transfer Capacitance | | 8 | | | F = 100 kHz | |
| E _{oss} | Coss Stored Energy | | 76 | | μЈ | Vac = 25 mV | |
| Eon | Turn-On Switching Energy (External Diode) | | 367 | | | V_{DS} = 800 V, V_{GS} = -4 V/15 V, I_D = 40 A, $R_{G(ext)}$ = | Fig. 26 |
| E _{OFF} | Turn Off Switching Energy (External Diode) | | 123 | | μJ | 2.5 Ω , L= 65.7 μ H, T _J = 175°C | |
| E _{on} | Turn-On Switching Energy (Body Diode FWD) | | 955 | | | V_{DS} = 800 V, V_{GS} = -4 V/15 V, I_D = 40 A, $R_{G(ext)}$ = | |
| E _{OFF} | Turn-Off Switching Energy (Body Diode FWD) | | 107 | | μJ | 2.5Ω , L= 65.7μ H, T_J = 175° C FWD = Internal Body Diode | Fig. 26 |
| t _{d(on)} | Turn-On Delay Time | | 25 | | | | Fig. 27 |
| t_{r} | Rise Time | | 18 | | | $V_{DD} = 800 \text{ V}, V_{GS} = -4 \text{ V}/15 \text{ V}$ $I_D = 40 \text{ A}, R_{G(ext)} = 2.5 \Omega, L = 65.7 \text{uH}$ | |
| $t_{d(off)}$ | Turn-Off Delay Time | | 32 | | ns | Timing relative to V _{DS} | |
| t_{f} | Fall Time | | 9 | | | inductive toda | |
| $R_{\text{G(int)}}$ | Internal Gate Resistance | | 1.7 | | Ω | f = 1 MHz, V _{AC} = 25 mV | |
| Q_gs | Gate to Source Charge | | 40 | 40 | | $V_{DS} = 800 \text{ V}, V_{GS} = -4 \text{ V}/15 \text{ V}$ | |
| Q_{gd} | Gate to Drain Charge | | 34 | _ | nC | I _D = 40 A | Fig. 12 |
| $Q_{\rm g}$ | Total Gate Charge | | 118 | | | Per IEC60747-8-4 pg 21 | |

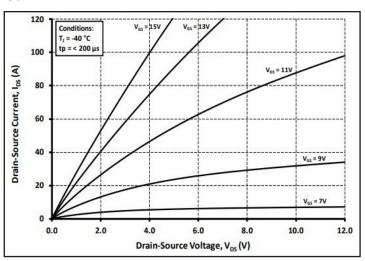
Reverse Diode Characteristics ($T_c = 25 \degree C$ unless otherwise specified)

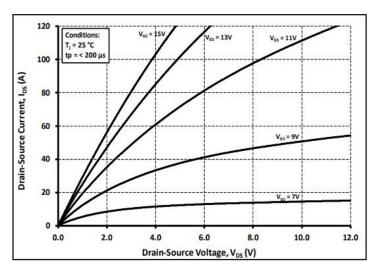
| Symbol | Parameter | Тур. | Max. | Unit | Test Conditions | Note |
|------------------|----------------------------------|------|------|------|---|------------|
| ., | | 4.6 | | V | $V_{GS} = -4 \text{ V, } I_{SD} = 20 \text{ A, } T_{J} = 25 ^{\circ}\text{C}$ | Fig. 8, 9, |
| V_{SD} | Diode Forward Voltage | 4.2 | | V | $V_{GS} = -4 \text{ V, } I_{SD} = 20 \text{ A, } T_{J} = 175 \text{ °C}$ | 10 |
| Is | Continuous Diode Forward Current | | 62 | А | V _{GS} = -4 V, T _C = 25 ° C | |
| I _{SM} | Diode pulse Current | | 264 | А | $V_{GS} = -4 \text{ V}$, pulse width t_P limited by T_{jmax} | |
| t _{rr} | Reverse Recover time | 27 | | ns | | |
| Q _{rr} | Reverse Recovery Charge | 478 | | nC | V _{cs} = -4 V, I _{sD} = 40 A, V _R = 800 V dif/dt = 2250 A/µs, T _i = 175 °C | |
| I _{rrm} | Peak Reverse Recovery Current | 27 | | А | | |

Thermal Characteristics

| Symbol | Parameter | Тур. | Unit | Test Conditions | Note |
|------------------|--|------|------|-----------------|---------|
| R_{JA} | Thermal Resistance Junction to Ambient | 40 | | | =: |
| R _{θJC} | Thermal Resistance from Junction to Case | 0.44 | °C/W | | Fig. 21 |

Typical Performance

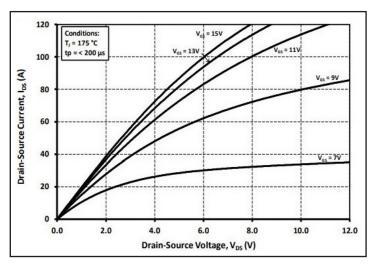




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Figure 1. Output Characteristics T_J = -40 °C





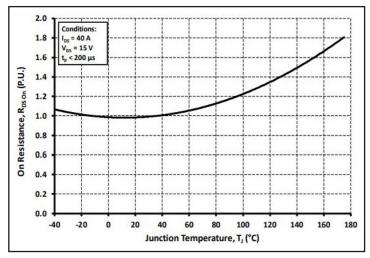
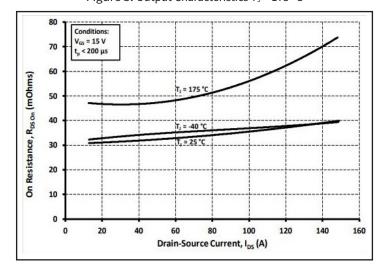


Figure 3. Output Characteristics T_J = 175 °C





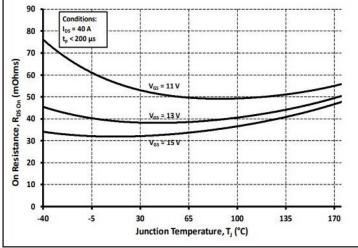
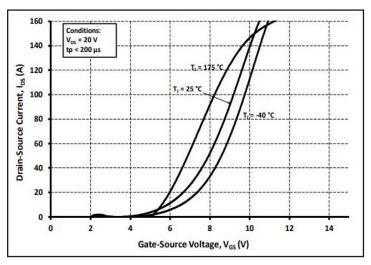


Figure 5. On-Resistance vs. Drain Current For Various Temperatures

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Figure 6. On-Resistance vs. Temperature For Various Gate Voltage



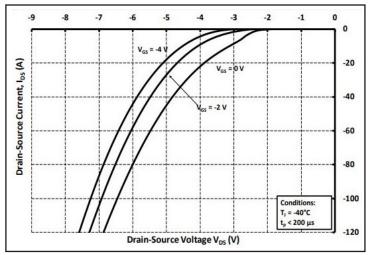
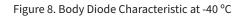
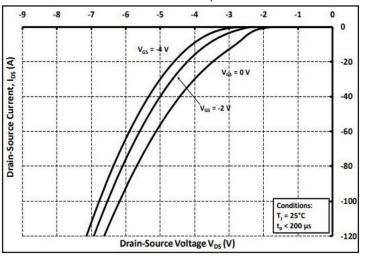


Figure 7. Transfer Characteristic for Various Junction Temperatures





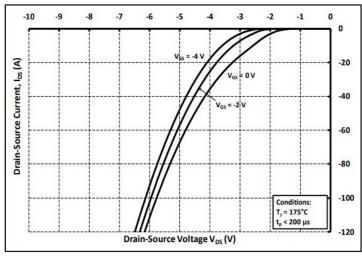
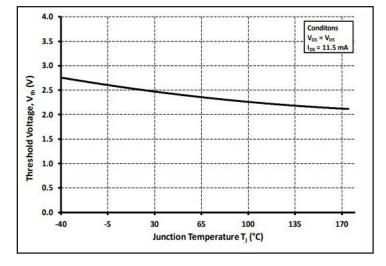


Figure 9. Body Diode Characteristic at 25 °C

Figure 10. Body Diode Characteristic at 175 °C



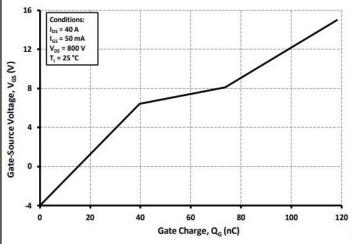
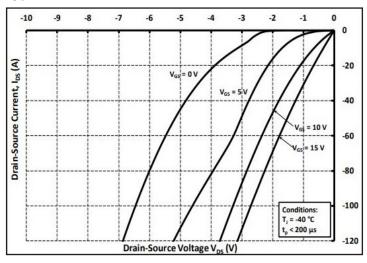


Figure 11. Threshold Voltage vs. Temperature

Figure 12. Gate Charge Characteristics



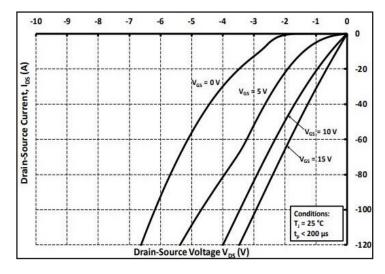
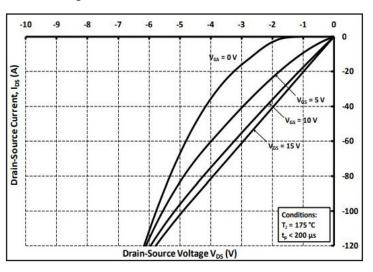


Figure 13. 3rd Quadrant Characteristic at -40 °C

Figure 14. 3rd Quadrant Characteristic at 25 °C



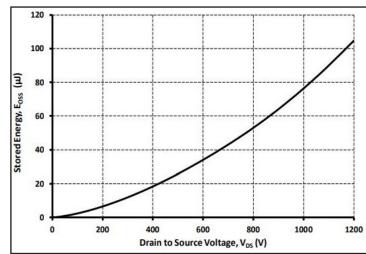
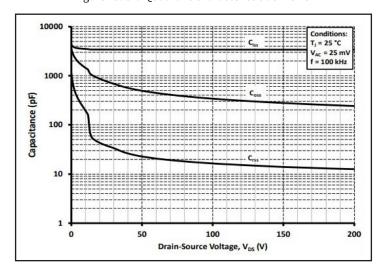


Figure 15. 3rd Quadrant Characteristic at 175 °C

Figure 16. Output Capacitor Stored Energy



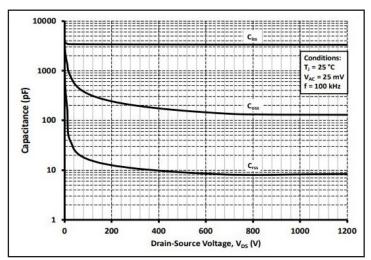
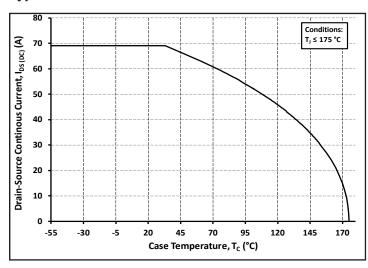


Figure 17. Capacitances vs. Drain-Source Voltage (0 - 200V)

Figure 18. Capacitances vs. Drain-Source Voltage (0 - 1200V)



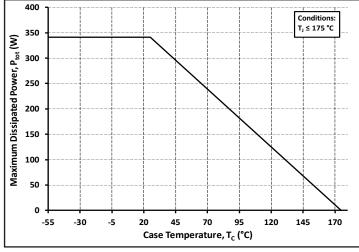
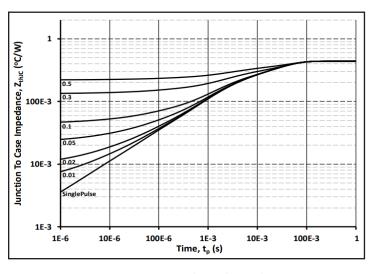


Figure 19. Continuous Drain Current Derating vs.

Case Temperature

Figure 20. Maximum Power Dissipation Derating vs.

Case Temperature



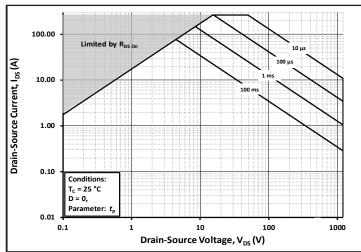
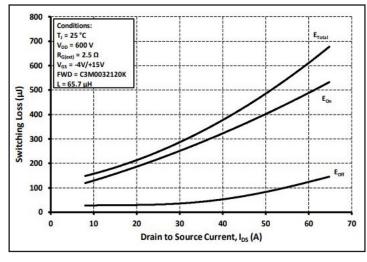


Figure 21. Transient Thermal Impedance (Junction - Case)

Figure 22. Safe Operating Area



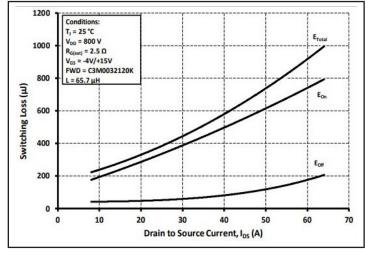


Figure 23. Clamped Inductive Switching Energy vs. Low Drain Current ($V_{\rm DD}$ = 600V)

Figure 24. Clamped Inductive Switching Energy vs. High Drain Current (V_{DD} = 800V)

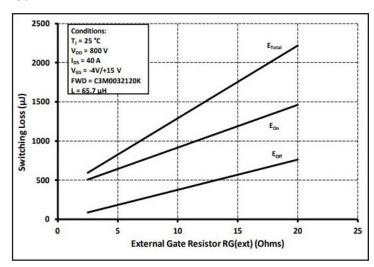


Figure 25. Clamped Inductive Switching Energy vs. $R_{G(ext)}$

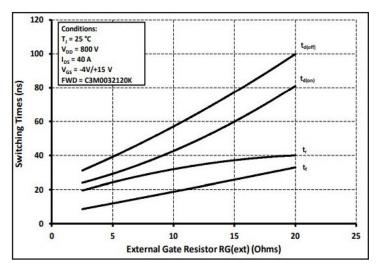


Figure 27. Switching Times vs. $R_{G(ext)}$

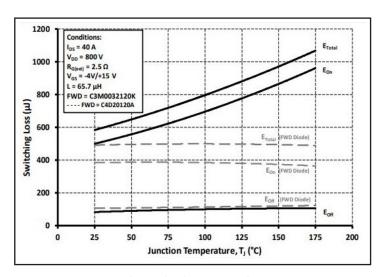


Figure 26. Clamped Inductive Switching Energy vs.
Temperature

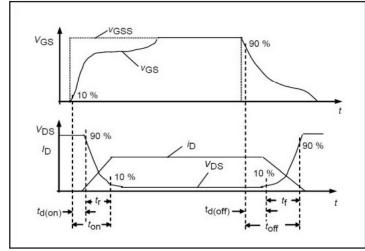


Figure 28. Switching Times Definition

Test Circuit Schematic

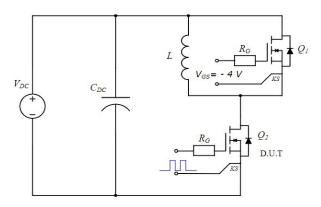
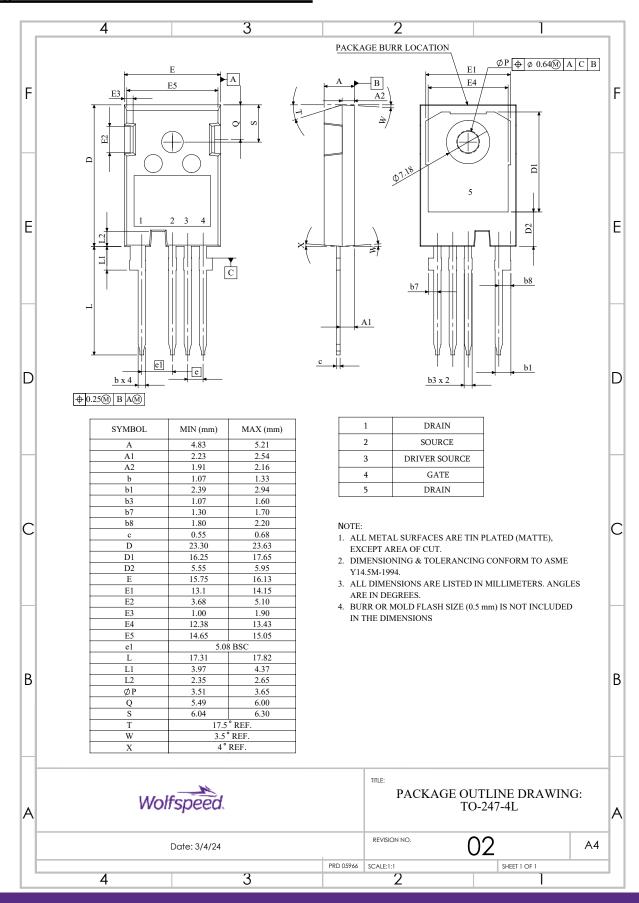
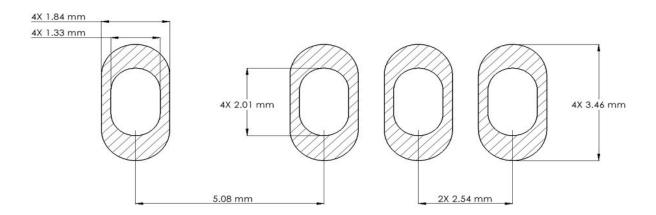


Figure 29. Clamped Inductive Switching Waveform Test Circuit

Package Dimensions



Recommended Solder Pad Layout



Revision history

| Document Version | Date of release | Description of changes |
|------------------|------------------|--|
| 3 | November-2020 | Initial datasheet |
| 4 | December-2023 | Update Package Drawing, package image, solder pad layout, added revision history table, Table 1 layout revised |
| 5 | February-2024 | Updated ID, IDM, Pd, and Rthj-c based off latest data |
| 6 | September - 2024 | Legal Disclaimer and POD |

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